

# Call for Papers: Microelectromechanical Systems

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## OBJECTIVES

Authors and presenters from academia and industry are invited to participate in this event to expand International cooperation, understanding and promotion of efforts and disciplines in the area of Microelectromechanical Systems (MEMS). Dissemination of knowledge by presenting research results and new developments in the areas of MEMS, NEMS, Electronic Packaging and Nanotechnology will serve as the foundation upon which the conference program of this area will be developed.

A variety of sessions is available for presentations as it allows flexibility to the authors. While most of the sessions will be of oral presentation format, few poster presentation sessions of the same quality as the oral presentations will also be available. All sessions are quality driven. Detailed session descriptions can be found on the conference website at: <http://www.asmeconferences.org/congress06>. There will be awards presented to the best papers in both poster and oral presentation sessions.

## LIST OF TOPICAL AREAS

Abstracts are invited for presentation and publication on the following key topics for all sessions:

- 1) Fabrication and Packaging
- 2) Applied Mechanics and Materials
- 3) Micro and Nano Devices
- 4) Test and Device Characterization
- 5) Design, Dynamics & Controls of Micro/Nano Systems (jointly with the Design Engineering Division)
- 6) BioMEMS (jointly with the Bioengineering Division)
- 7) MicroFluidics and Thermal Systems (jointly with the Fluids Engineering Division)

## ABSTRACTS

Authors should submit a 400-word text-only abstract to:  
<http://www.asmeconferences.org/Congress06>

**ABSTRACT DUE DATE: March 6, 2006**